

# VUTS010R055NA

Datasheet

# VMDSEMI

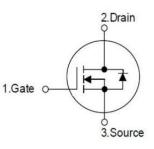


#### VUTS010R055NA

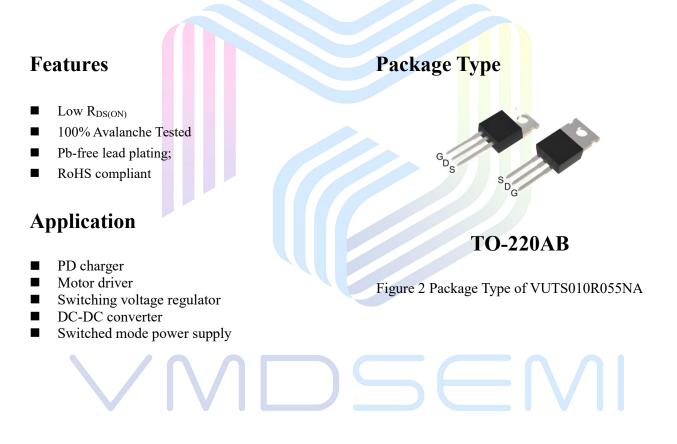
# **General Description**

#### Symbol

V <sub>(BR)DSS</sub>	R <sub>DS(ON)_max</sub>	ID
100V	5.5mΩ@10V	200A



#### Figure 1 Symbol of VUTS010R055NA



### **Ordering Information**

Product Name	Package			
VUTS010R055NA	TO-220AB			



### VUTS010R055NA

# Absolute Maximum Ratings (T<sub>A</sub>= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	100	V
Gate-Source Voltage		V <sub>GSS</sub>	±25	V
Continuous Drain Current	$T_{C}=25^{\circ}C$	т	200	A
Continuous Drain Current	T <sub>C</sub> =100°C	- I <sub>D</sub>	142	A
Pulsed Drain Current <sup>Note 2</sup>	$T_C=25^{\circ}C$	I <sub>D.pulse</sub>	800	A
Continuous Diode Forward Current	$T_C=25^{\circ}C$	Is	200	A
Continuous Drain Current	$T_A=25^{\circ}C$	т	15	A
Continuous Drain Current	$T_A=70^{\circ}C$	- I <sub>DSM</sub>	12	A
Max Power Dissipation	$T_{\rm C}=25^{\rm o}{\rm C}$	PD	375	W
Max Power Dissipation <sup>Note 3</sup>	T <sub>A</sub> =25°C	P <sub>DSM</sub>	2	W
Avalanche Energy, Single Pulse <sup>Note 4</sup>		Eas	900	mJ
Operation and storage temperature		T <sub>J</sub> ,T <sub>STG</sub>	- <mark>5</mark> 5 to 175	°C

# **Thermal Resistance**

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		0.4	0.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$		62.5	75	C/W

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#### VUTS010R055NA

Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics		•			-		
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	100			V
Zero Gate Voltage Drain Current		- I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1	uA
Zero Gate Voltage Drain Current $T_J$ = 125 °C			V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			100	uA
Gate-Body Leakage Current	Forward	I <sub>GSSF</sub>	$V_{GS}=25V, V_{DS}=0V$			100	nA
	Reverse	I <sub>GSSR</sub>	I <sub>GSSR</sub> V <sub>GS</sub> =-25V, V <sub>DS</sub> =0V			-100	
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2.4	3	3.6	V
Drain-Source On-Resistance <sup>Note1</sup>		- R <sub>DS(ON)</sub>			4.5	5.5	mΩ
Drain-Source On-Resistance <sup>Note1</sup> T <sub>J</sub> = 100 °C			$V_{GS}=10V, I_{D}=80A$		6.5		
Gate resistance		R <sub>G</sub>	f=1 MHz, Open drain	0.2	2.3	5	Ω
Dynamic Characteristics							
Input Capacitance		CISS	V <sub>DS</sub> =30V	11065	14755	19625	pF
Output Capacitance		Coss	V <sub>GS</sub> =0V	500	665	885	pF
Reverse Transfer Capacitance		C <sub>RSS</sub>	f=1MHz	370	495	660	pF
Turn-on Delay Time		t <sub>d(on)</sub>	V <sub>DS</sub> =50V		35		
Rise Time		tr	I <sub>D</sub> =40A		67		
Turn-off Delay Time		t <sub>d(off)</sub>	$R_G=3\Omega$		128		ns
Fall Time		t <sub>f</sub>	V <sub>GS</sub> =10V		64		
Gate Charge Characteristics							
Gate to Source Charge	ate to Source Charge		V <sub>GS</sub> =10V		59	78	
Gate to Drain Charge		Q <sub>gd</sub>	$V_{DS}=50V$		60	90	nC
Gate Charge Total		Qg	I <sub>D</sub> =40A		232	309	
<b>Reverse Diode Characteristic</b>	s						
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	$V_{GS}=0V, I_{SD}=80A$		0.9	1.2	V
Reverse Recovery Time		t <sub>rr</sub>	$I_{SD}=40AV_{GS}=0V$		44	88	ns
Reverse Recovery Charge		Qrr	di/dt=100A/us		77	154	nC
Notes:							

### Electrical Characteristics(T<sub>J</sub>= 25 °C, unless otherwise specified)

1. Pulse width  $\leq 380 \mu s$ ; duty cycle  $\leq 2\%$ .

2. Repetitive rating; pulse width limited by max junction temperature.

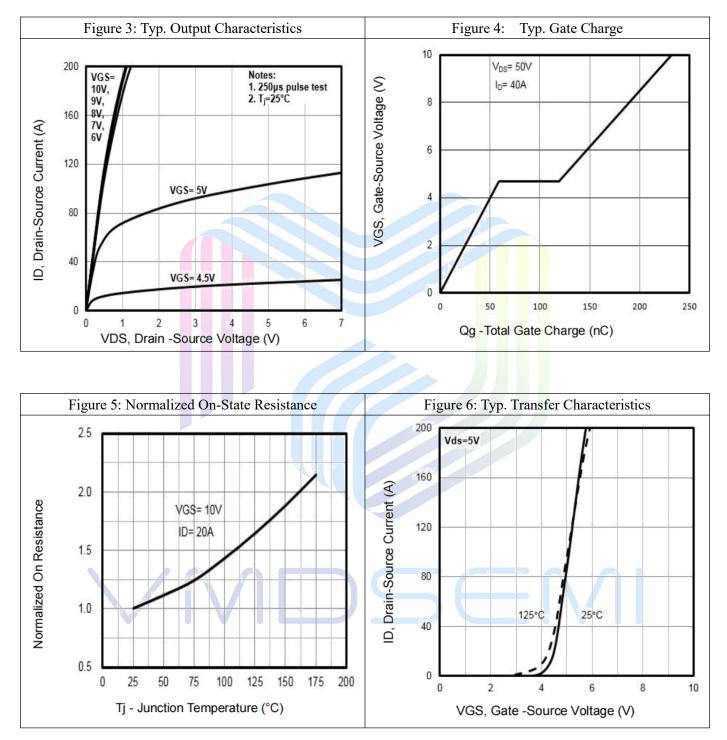
3. The power dissipation  $P_{DSM}$  is based on  $R_{\theta JA}$  and  $@T_J=150^{\circ}C$ .

4. Limited by  $T_{Jmax}$ , starting  $T_J = 25^{\circ}C$ , L = 0.5mH,  $R_G = 25\Omega$ ,  $I_{AS} = 60A$ ,  $V_{GS} = 10V$ .



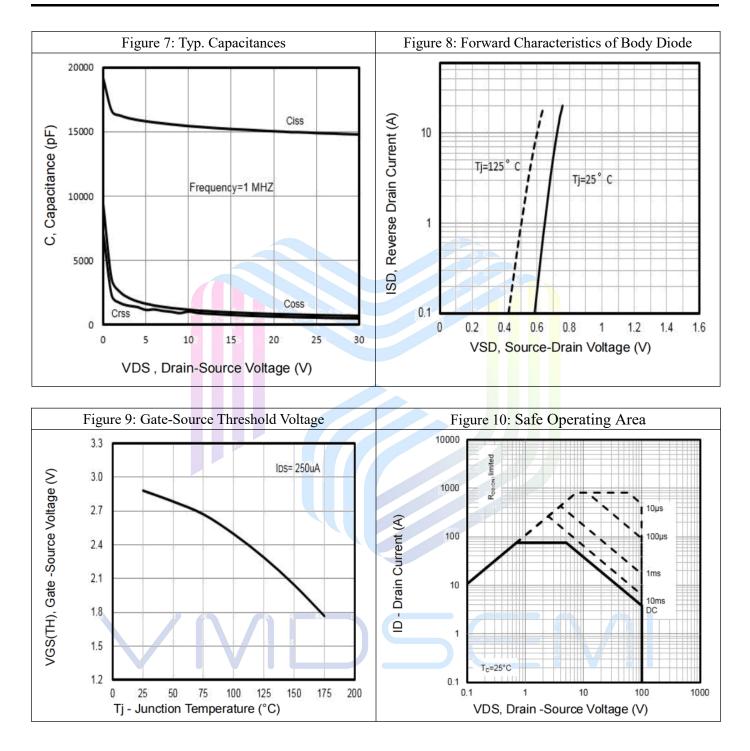
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# **Typical Performance Characteristics**



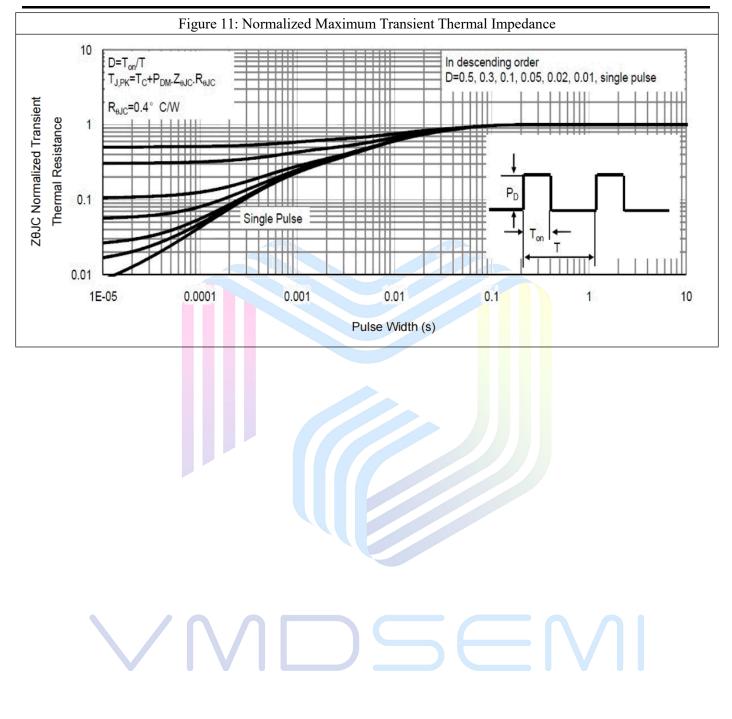


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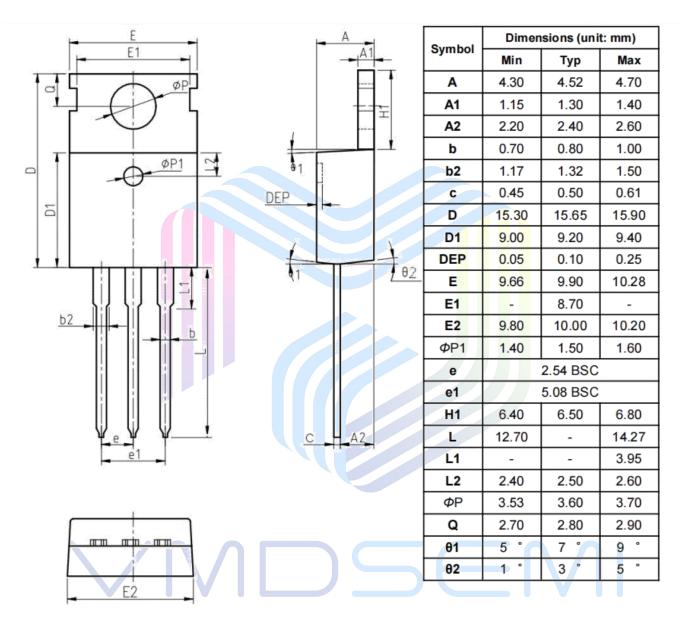




#### VUTS010R055NA

#### **Mechanical Dimensions**

#### Package Information TO-220AB



Notes:

- 1. Refer to JEDEC TO-220 variation AB
- 2. Dimension "D" and "E" do NOT include mold flash. Mold flash shall not exceed 0.127mm per side.



#### VUTS010R055NA

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